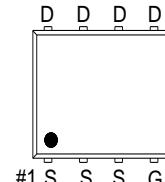
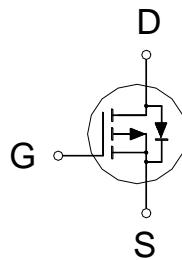


**NIKO-SEM**

**P-Channel Logic Level Enhancement Mode  
Field Effect Transistor PE551BA**  
**PDFN 3x3P**  
**Halogen-free & Lead-Free**

**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-30V	20m $\Omega$	-22A



G : GATE  
D : DRAIN  
S : SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Continuous Drain Current <sup>4</sup>	$I_D$	-22	A
		-14	
		-9	
		-7	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	-40	
Avalanche Current	$I_{AS}$	-23	
Avalanche Energy	$E_{AS}$	26	mJ
Power Dissipation <sup>3</sup>	$P_D$	17	W
		7	
		3	
		2	
Junction & Storage Temperature Range	$T_j, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10\text{s}$		40	°C / W
Junction-to-Ambient <sup>2</sup>			65	
Junction-to-Case			7.2	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10\text{s}$  value.

<sup>4</sup>Package limitation current is -21A

**NIKO-SEM****P-Channel Logic Level Enhancement Mode****PE551BA****Field Effect Transistor****PDFN 3x3P****Halogen-free & Lead-Free****ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.3	-1.6	-2.3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 25\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
		$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 55^\circ\text{C}$			-10	
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = -10\text{V}, I_D = -7\text{A}$		15	20	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -7\text{A}$		23	30	
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = -10\text{V}, I_D = -7\text{A}$		25		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -15\text{V}, f = 1\text{MHz}$		1009		pF
Output Capacitance	$C_{\text{oss}}$			154		
Reverse Transfer Capacitance	$C_{\text{rss}}$			121		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		8		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_{\text{g}}(\text{VGS}=-10\text{V})$	$V_{\text{DS}} = -15\text{V}, I_D = -7\text{A}$		21		nC
	$Q_{\text{g}}(\text{VGS}=-4.5\text{V})$			11		
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$			3		
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$			6		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}$ $I_D \cong -7\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$		22		nS
Rise Time <sup>2</sup>	$t_r$			16		
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$			50		
Fall Time <sup>2</sup>	$t_f$			25		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$				-13	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$	$I_F = -7\text{A}, V_{\text{GS}} = 0\text{V}$			-1.3	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = -7\text{A}, dI_F/dt = 100 \text{ A} / \mu\text{s}$		11		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			3		nC

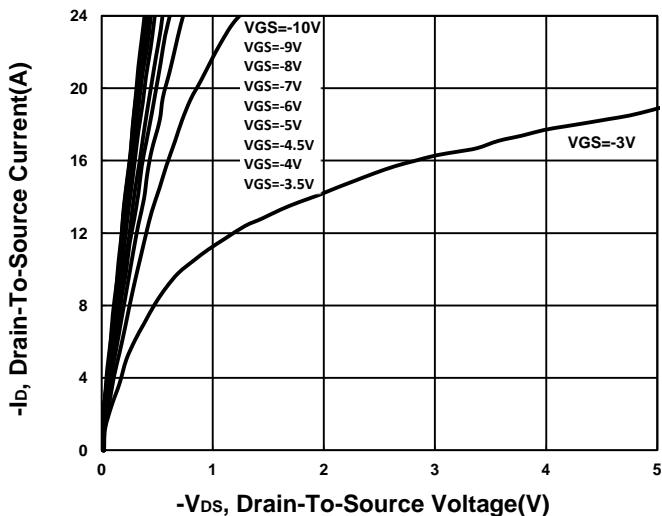
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.

**NIKO-SEM**

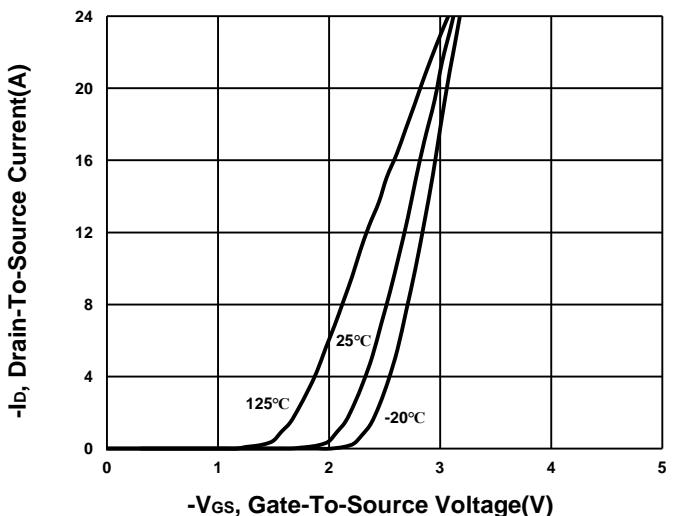
**P-Channel Logic Level Enhancement Mode  
Field Effect Transistor**

**PE551BA  
PDFN 3x3P  
Halogen-free & Lead-Free**

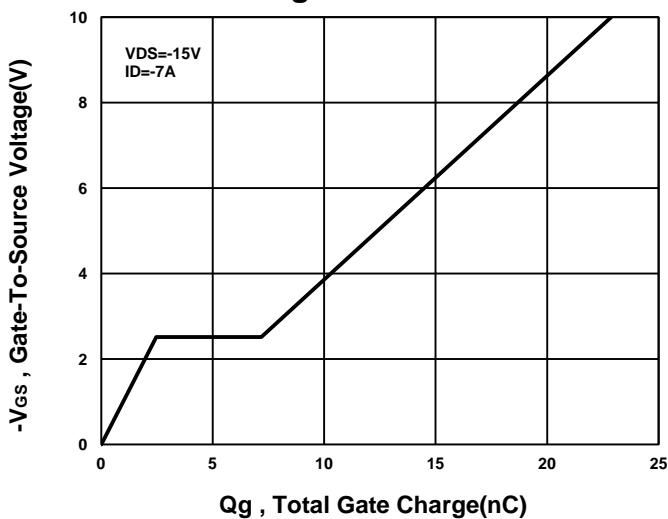
### Output Characteristics



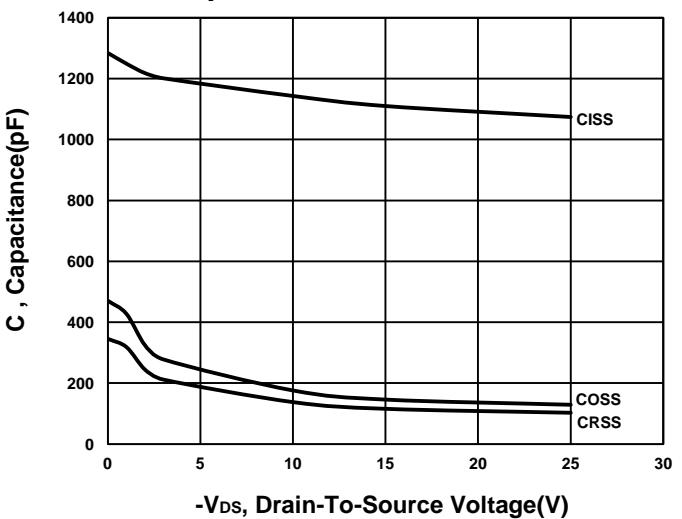
### Transfer Characteristics



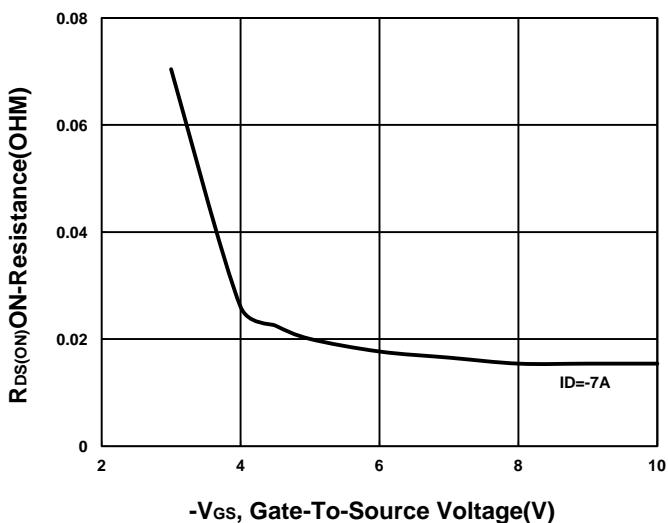
### Gate charge Characteristics



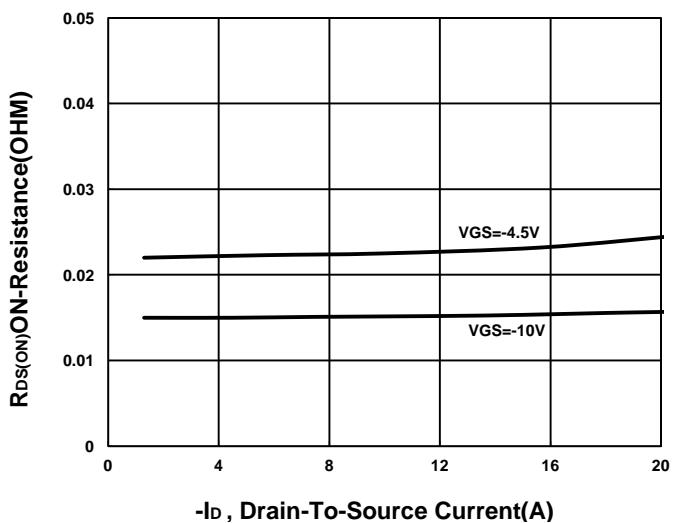
### Capacitance Characteristic

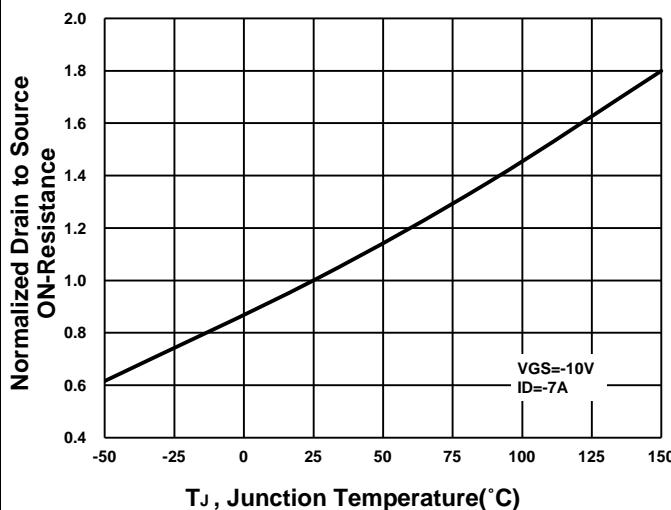
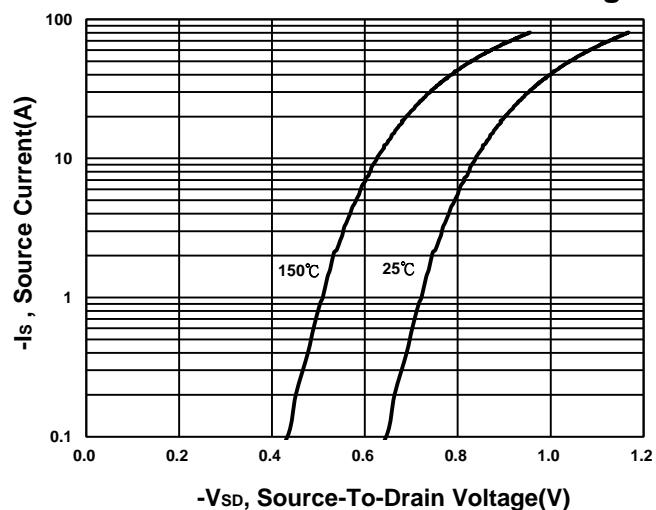
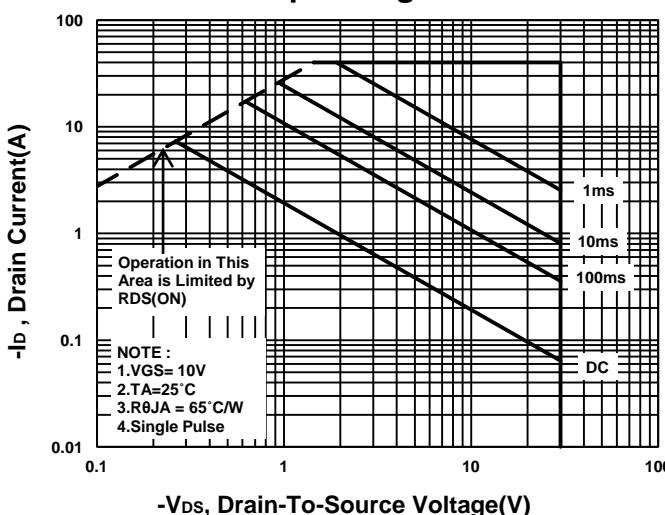
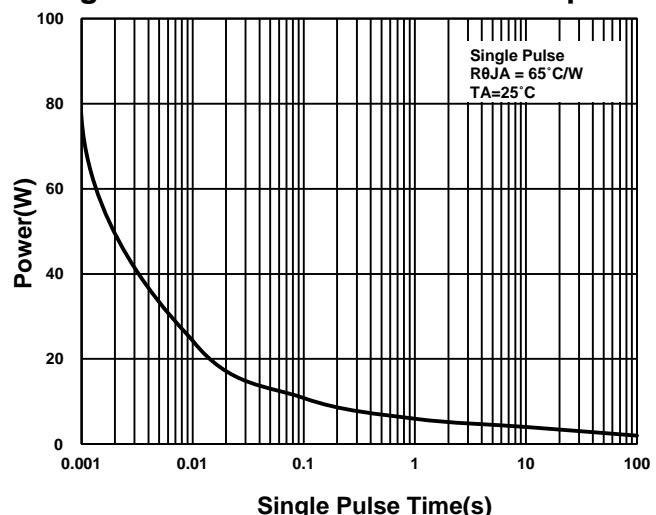
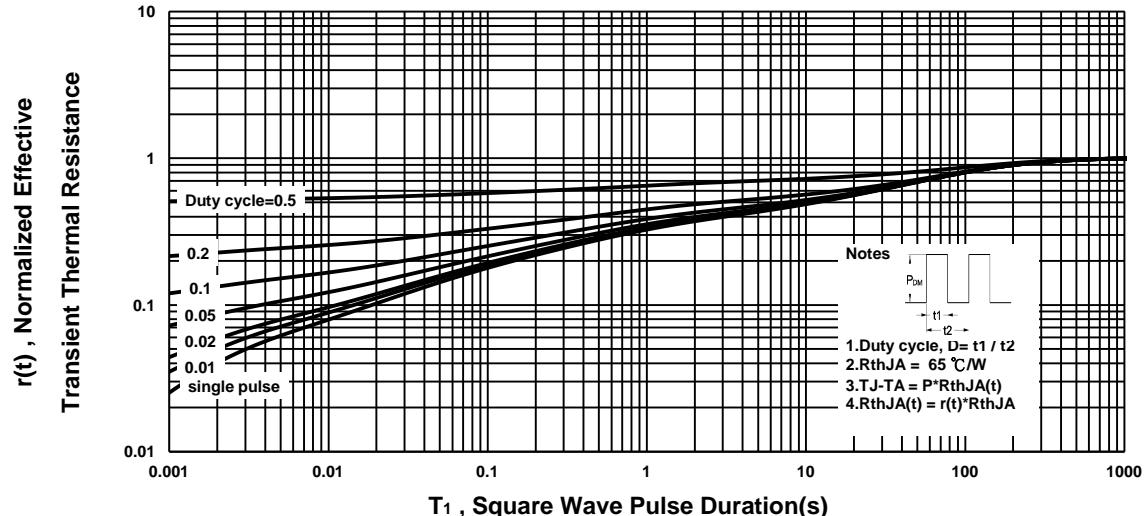


### On-Resistance VS Gate-To-Source



### On-Resistance VS Drain Current



**NIKO-SEM****P-Channel Logic Level Enhancement Mode****PE551BA****Field Effect Transistor****PDFN 3x3P****Halogen-free & Lead-Free****On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

**NIKO-SEM**

**P-Channel Logic Level Enhancement Mode**

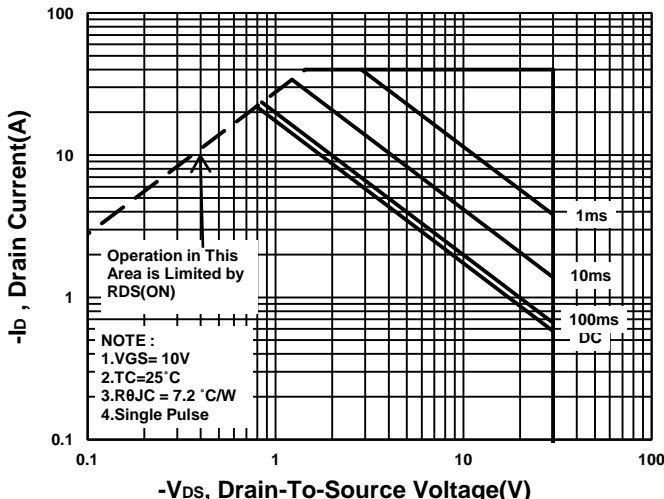
**PE551BA**

**Field Effect Transistor**

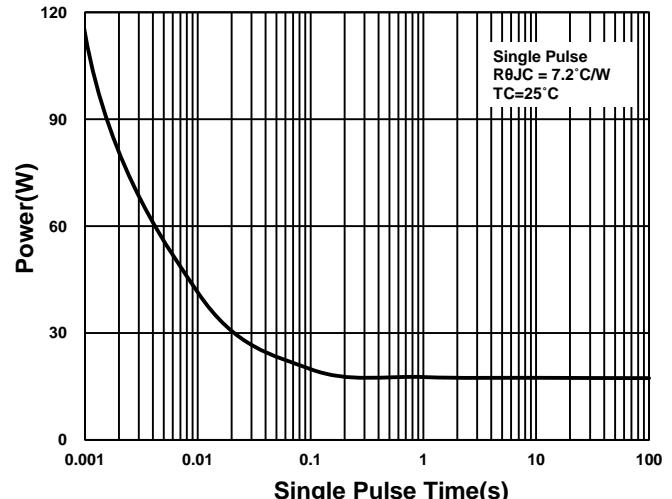
**PDFN 3x3P**

**Halogen-free & Lead-Free**

### Safe Operating Area



### Single Pulse Maximum Power Dissipation



### Transient Thermal Response Curve

